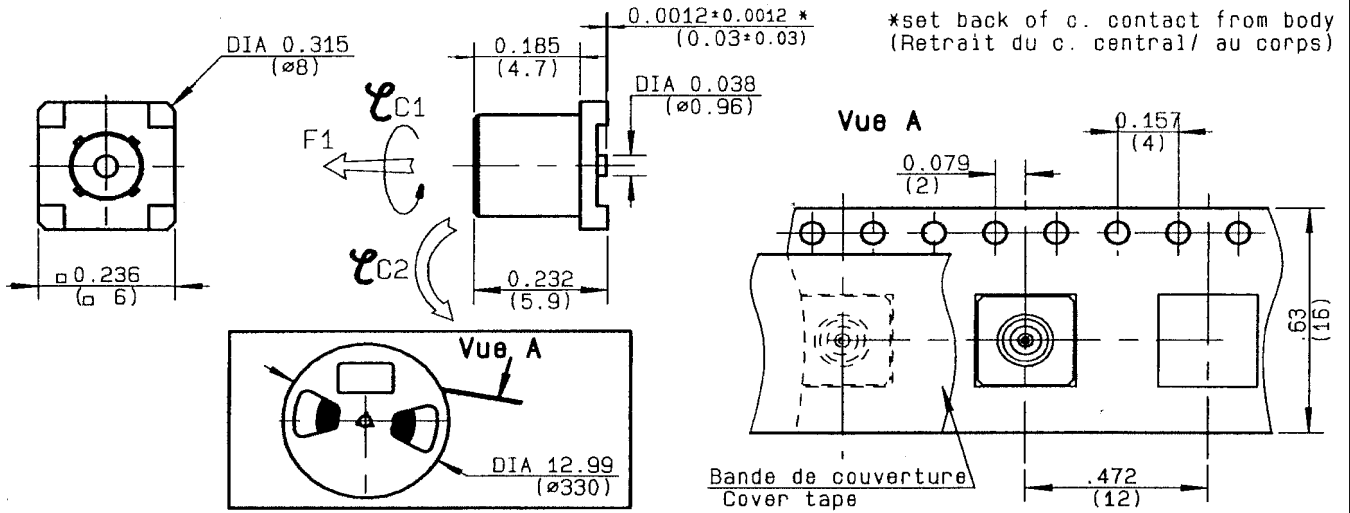


**STRAIGHT FEMALE RECEPTACLE FOR PCB**

**R113.424.020**

**SMT TYPE - REEL OF 500**

Series : MCX



All dimensions are in mm.



COMPONENTS	MATERIALS	PLATINGS (µm)
<b>BODY</b>	<b>BRASS</b>	<b>GOLD 0.2 OVER NICKEL 2</b>
<b>CENTER CONTACT</b>	<b>BERYLLIUM COPPER</b>	<b>GOLD 0.5 OVER NICKEL 2</b>
<b>OUTER CONTACT</b>	-	-
<b>INSULATOR</b>	<b>PTFE</b>	-
<b>GASKET</b>	-	-
<b>OTHERS PARTS</b>	-	-
-	-	-
-	-	-

Issue : 0412 D

In the effort to improve our products, we reserve the right to make changes judged to be necessary.



**STRAIGHT FEMALE RECEPTACLE FOR PCB**

**R113.424.020**

**SMT TYPE - REEL OF 500**

Series : **MCX**

**PACKAGING**

**SPECIFICATION**

Standard	Unit	Other
<b>500</b>	-	<b>Contact us</b>

**ELECTRICAL CHARACTERISTICS**

**ENVIRONMENTAL**

Impedance		<b>50</b> Ω
Frequency		<b>0-6</b> GHz
VSWR	<b>1.05</b> +	<b>0.050</b> x F(GHz) Maxi
Insertion loss		<b>0.03</b> √F(GHz) dB Maxi
RF leakage	- (	<b>NA</b> - F(GHz)) dB Maxi
Voltage rating		<b>335</b> Veff Maxi
Dielectric withstanding voltage		<b>1000</b> Veff mini
Insulation resistance		<b>1000</b> MΩ mini

Operating temperature	<b>-55/+155</b> ° C
Hermetic seal	<b>NA</b> Atm.cm3/s
Panel leakage	<b>NA</b>

**OTHERS CHARACTERISTICS**

Assembly instruction

Others :

Drawing page 1:  
FORCE F1:90N-TORQUES C1:45Ncm-C2:80Ncm

**MECHANICAL CHARACTERISTICS**

Center contact retention		
Axial force – Mating end		<b>10</b> N mini
Axial force – Opposite end		<b>10</b> N mini
Torque		<b>NA</b> N.cm mini
Recommended torque		
Mating		<b>NA</b> N.cm
Panel nut		<b>NA</b> N.cm
Mating life		<b>500</b> Cycles mini
Weight		<b>0.600</b> g

Issue : 0412 D

In the effort to improve our products, we reserve the right to make changes judged to be necessary.



**STRAIGHT FEMALE RECEPTACLE FOR PCB**

**R113.424.020**

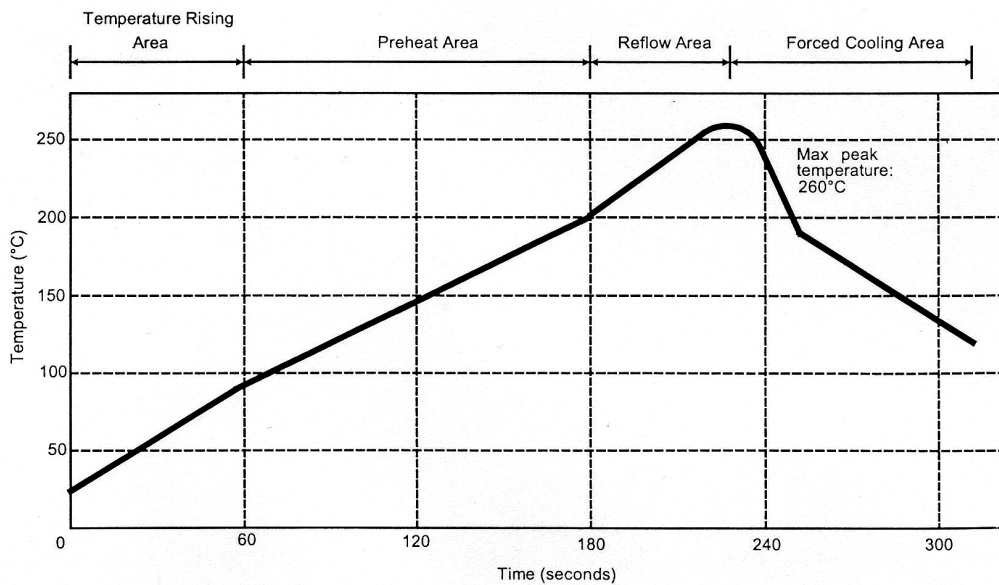
**SMT TYPE - REEL OF 500**

Series : MCX

**SOLDER PROCEDURE**

1. Deposit solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application.  
We recommend a low residue flux. We advise a thickness of 150 microms mini. (.006 inch mini).  
Verify that the edges of the zone are clean.
2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type. Aspiration port (see page 4) centered into body and push against it.  
A video camera is recommended for positioning of the component . Adhesive agents must not be used on the receptacle.
3. Soldering by infra-red reflow.  
Below please find ,the typical profile to use.
4. Cleaning of printed circuit boards.
5. Verification of solder joints and position of the component by visual inspection.

**TEMPERATURE PROFIL**



Parmeter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to - 4	°C/sec
Max dwell time above 100°C	420	sec

Issue : 0412 D

In the effort to improve our products, we reserve the right to make changes judged to be necessary.

